

General Description

The SY20737H is a high-voltage input Linear Voltage Regulator (LDO) operating with input voltages from 4V to 36V and capable of delivering 500mA to a load, with ultralow ground current and low dropout voltage.

The SY20737H has an adjustable output that can be configured using two external resistors. The device offers protection features, including an over-current limit, output short and over-temperature protections.

The Enable input allows disabling the part to reduce power consumption.

The High-Power Supply Rejection Ratio (PSRR) and low noise makes this part suitable for many applications in industrial and consumer products.

The SY20737H is available in a compact DFN 2mm×3mm-8pin package.

Features

Input Voltage Range: 4V to 36V

V_{ABS} = 40V

V_{FB}: 1.235V (±1%)

• Output Voltage Tolerance: ±1%

Line Regulation: 0.2%/V

Load Regulation: 0.25%

PSRR: 60dB

Noise Level: 150µVRMS

Operating T_J: -40°C to 125°C

Auto Retry-During Fault Conditions

Compact Package: DFN2x3-8

Applications

Portable Consumer Equipment

Portable Instrumentation

Industrial Equipment

• SMPS Post Regulators

Typical Application

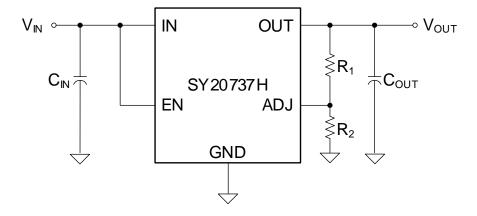


Figure 1. Schematic Diagram

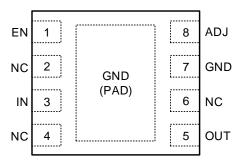


Ordering Information

Ordering Part Number	Package Type	Top Mark	
SY20737HDGD	DFN2×3-8 RoHS Compliant and Halogen Free	4A <i>xyz</i>	

x=year code, y=week code, z= lot number code

Pinout (top view)



Pin Description

Pin Name	Pin Number	Pin Description
EN	1	Enable. CMOS-compatible control input. Logic high = enable. Logic low or open = shutdown.
NC	2, 4, 6	No connection.
IN	3	Supply input.
OUT	5	Regulator output.
GND	7	Ground.
ADJ	8	Adjustable part only. Feedback input. Connect to resistive voltage-divider network.

Block Diagram

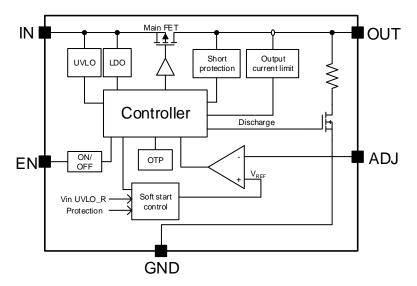


Figure 2. Block Diagram



Absolute Maximum Ratings

Parameter (Note1)	Min	Max	Unit
IN, EN, OUT, ADJ	-0.3	40	V
Lead Temperature (Soldering, 10 sec.)		260	
Junction Temperature, Operating	-40	150	°C
Storage Temperature	-65	150	

Thermal Information

Parameter (Note2)	Тур	Unit
θ _{JA} Junction-to-ambient Thermal Resistance	46	
θ _{JB} Junction-to-Board Thermal Resistance	22.5	°C/W
θ _{JC} Junction-to-case Thermal Resistance	28	
P_D Power Dissipation $T_A = 25^{\circ}C$	2.17	W

Recommended Operating Conditions

Parameter (Note 3)	Min	Max	Unit
IN	4	36	W
EN, OUT, ADJ	0	36	V
Junction Temperature, Operating	-40	125	°C



Electrical Characteristics

 $(V_{IN} = V_{EN} = 12V, T_J = -40 ^{\circ}C \sim 125 ^{\circ}C, typical values are at T_J = 25 ^{\circ}C, unless otherwise specified, the values are guaranteed by test, design, or statistical correlation.)$

Parameter	Symbol	Test Conditions		Тур	Max	Unit	
Input Voltage	V _{IN}		4		36	V	
Defenses Veltare	\/	T _A = 25°C	1.223	1.235	1.247	V	
Reference Voltage	V _{REF}	T _J = -40°C ~125°C	1.210	1.235	1.260	V	
Line Regulation	ΔV_{LNR}	I _{OUT} = 10mA, 4V ≤ V _{IN} ≤36V		1	1.5	mV/V	
Load Regulation	ΔV_{LDR}	$V_{IN} = 5V$, $10mA \le I_{OUT} \le 0.5A$,		0.25	1.0	%	
		I _{OUT} = 10mA		10	20	mV	
Dropout Voltage	ΔV_{DROP}	I _{OUT} = 300mA		300	540	mV	
		I _{OUT} = 500mA		500	750	mV	
Shutdown Current	I _{SHDN}	V _{EN} =0V, V _{IN} =24V			5	μA	
		No Load		7	14	μA	
		I∟=0.1mA		90	190		
Ground Pin Current	I _{GND}	IL=50mA		250	900	μA	
		I∟=150mA		1.0	2.5	mA	
		I _L =500mA		6.5	30.0		
Output Current	lo	V _{IN} =V _{OUT} +1V	0		500	mA	
Current Limit	I _{LIMIT}	V _{OUT} =0.9×V _{OUT} (normal)		900	1200	mA	
Input Voltage UVLO Threshold	V _{UVLO}	V _{IN} rising			3.9	V	
UVLO Hysteresis	Vuvlo, HYS			200		mV	
Shutdown Discharge Resistance	R _{DIS}			600		Ω	
Ripple Rejection	PSRR			60		dB	
Output Noise	емо	$I_L = 10$ mA, $C_L = 1.0$ μ F, $C_{IN} = 1$ μ F, $(10$ Hz $- 100$ kHz)		150		μV _{RMS}	
Enable Input Logic-low Voltage	VIL	OFF			0.4	V	
Enable Input Logic-high Voltage	VIH	ON	1.5			V	
Thermal Shutdown Temperature	T _{SD}			150		°C	
Thermal Shutdown Hysteresis	T _{HYS}			20		°C	

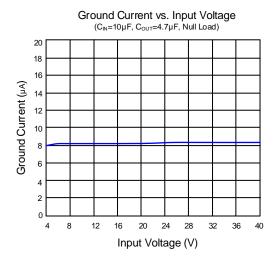
Note 1: Stresses beyond the "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

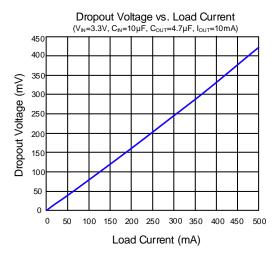
Note 2: θ_{JA} is measured in the natural convection at $T_A = 25^{\circ}C$ on a high effective single layer thermal conductivity test board of JESD51-2, -5, -7, -8, -14 thermal measurement standard.

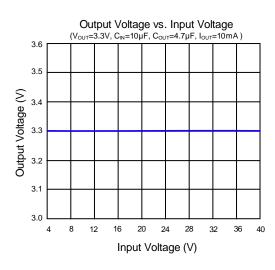
Note 3: The device is not guaranteed to function outside its operating conditions.

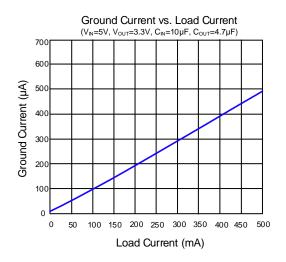


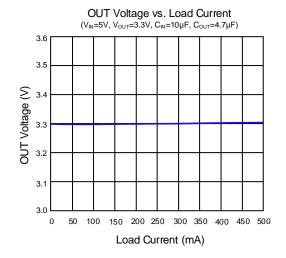
Typical Performance Characteristics

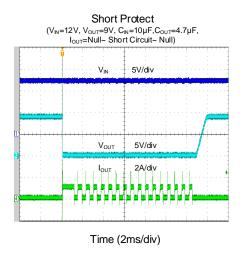








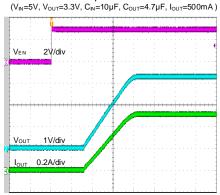




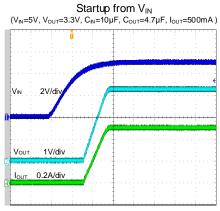






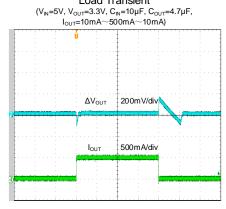


Time (400µs/div)



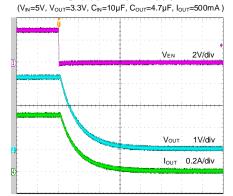
Time (800µs/div)

Load Transient

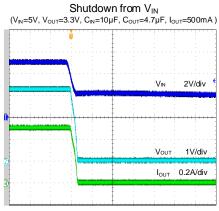


Time (100µs/div)

Shutdown from Enable

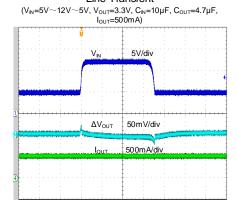


Time (40µs/div)



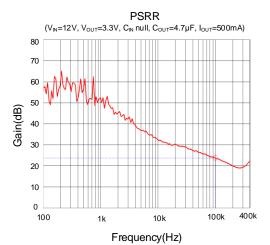
Time (2ms/div)

Line Transient



Time (2ms/div)







Application Information

The SY20737H is a 500mA high-current capacity linear regulator with ultra-low ground current and low dropout voltage. The SY20737H has an adjustable output that can be set by two external resistors. The device provides protection features, including over-current limit, output short and over-temperature protections.

Feedback Resistor Dividers R1 and R2:

Choose R_1 and R_2 to program the proper output voltage. To minimize the power consumption under light loads, choosing large resistance values for both R1 and R2 is recommended. A value of between $10k\Omega$ and $10M\Omega$ is recommended for both resistors. As an example, for a V_{OUT} of 3.3V, if $R_1{=}50.1k\Omega$ is chosen, then using the following equation, R_2 can be calculated to be $30k\Omega$:

$$R_{2} = \frac{1.235 \text{V}}{\text{V}_{\text{OUT}} - 1.235 \text{V}} \times R_{1}$$

$$\downarrow \text{V}_{\text{OUT}}$$

$$\uparrow \text{V}_{\text{OUT}}$$

$$\uparrow \text{R}_{1}$$

$$\downarrow \text{GND}$$

$$\downarrow \text{R}_{2}$$

Input Capacitor Cin:

An input capacitor of about $10\mu F$ between the device input and ground pin is required. A typical X5R or better grade ceramic capacitor is recommended for most applications. Place the input capacitor as close as practical to the device to minimize the input noise.

Output Capacitor Cout:

The SY20737H is designed specifically to work with very small ceramic output capacitors for transient stability. A 4.7µF output capacitance can be used in this application. Higher capacitance values help to improve transient response. The output capacitor's ESR is critical because it forms a zero to provide phase lead which is required for loop stability.

Dropout Voltage:

The SY20737H has a very low dropout voltage due to its extra low $R_{DS(ON)}$ of the main PMOS, which determines the lowest usable supply.

 $V_{DROPOUT}=V_{IN}-V_{OUT}=R_{DS(ON)}\times I_{OUT}$

Over-Current and Short-Circuit Protection:

The device includes over-current and short-circuit protection. The current limiting circuit regulates the output current to its limit threshold to protect the device from damage. Under over-current or short-circuit conditions, the dissipated power on device can be high, which may trigger thermal protection.

Thermal Considerations:

The SY20737H can deliver a current of up to 500mA over the full operating temperature range. However, the maximum output current must be derated at a higher ambient temperature. Under all operating conditions the junction temperature must be within the range specified. The LDO power dissipation can be calculated based on the output current and the voltage drop across the regulator.

The dissipated power, P_D , can be calculated using the following equation:

PD=(VIN-VOUT)×IOUT+VIN×IGND

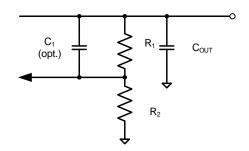
The operating junction temperature can be estimated by the following thermal formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A)/\theta_{JA}$$

Where $T_{J(MAX)}$ is the maximum junction temperature of die (125°C), T_A is the maximum ambient temperature and θ_{JA} is the junction to ambient thermal resistance for the package (46°C/W).

Load Transient Considerations:

The SY20737H integrates the compensation components to achieve stability and fast transient response. In some applications, adding a small ceramic capacitor in parallel with R1 may further speed up the load transient responses and is thus recommended for applications with large load transient step requirements.





PCB Layout Guide:

For the best performance of the SY20737H, the following guidelines must be followed:

- 1. Keep all power traces as short and wide as possible. A 2-layer- or 4-layer board is recommended for improved thermal performance and current flow capability.
- 2. Place the input/output capacitor close to the IC for better transient performance.
- 3. Maximize the copper area connected to GND and the exposed pad of the package to improve heat dissipation.

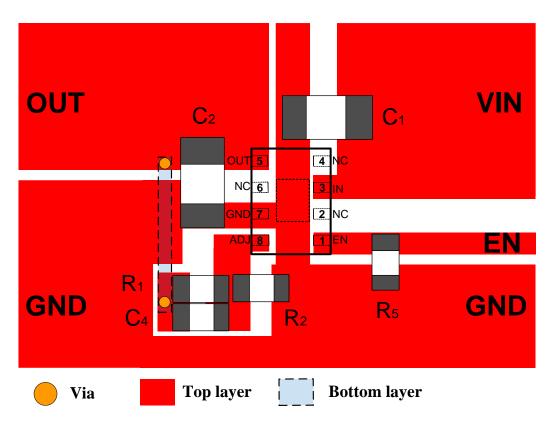
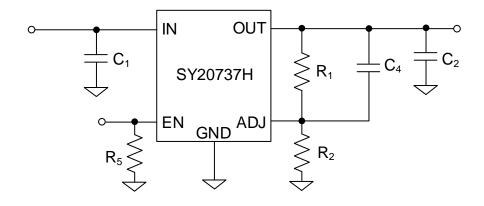


Figure 3. PCB Layout Suggestion



Application Schematic (Vout=3.3V)

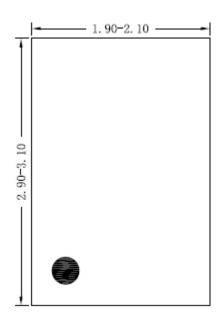


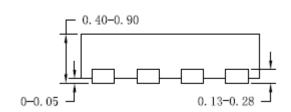
BOM List

Reference Designator	Description	Part Number	Manufacturer
C ₁	10μF/50V/X5R,1206	GRM31CR61H106K	Murata
C ₂	4.7μF/25V/X5R,1206	GRM31CR61E475K	Murata
R ₁	50.1kΩ , 1%, 0603		
R ₂	30kΩ, 1%, 0603		
R ₅	1ΜΩ, 1%, 0603		

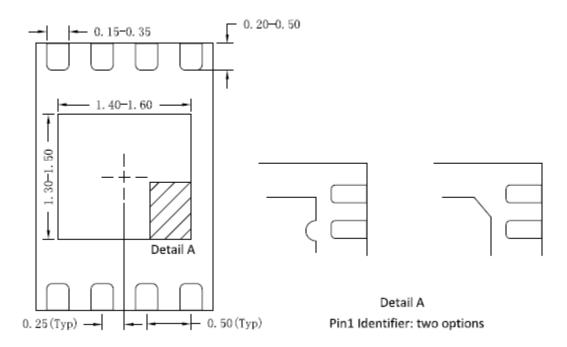


DFN2×3-8 Package Outline



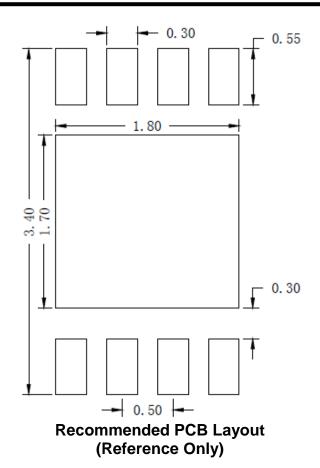


Top View Side View



Bottom View





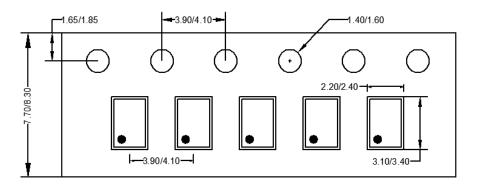
Note: All dimensions are in millimeters and exclude mold flash and metal burr.

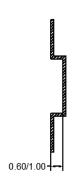
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Taping & Reel Specification

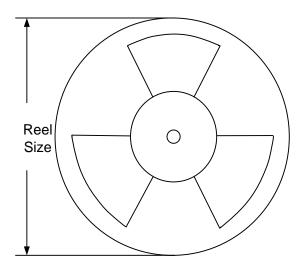
1. DFN2×3-8 Taping Orientation





Feeding direction__

2. Carrier Tape & Reel Specification for Packages



Package	Tape width (mm)	Pocket	Reel size	Trailer	Leader length	Qty per
type		pitch(mm)	(Inch)	length(mm)	(mm)	reel
DFN2×3	8	4	7"	400	160	3000

3. Others: NA



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Revision History

The revision history provided is for informational purposes only and is believed to be accurate; however, it is not warranted. Please reference the latest revision.

Date	Revision	Change
Sep.27, 2023	Revision 1.0	Language improvements for clarity.
Jul.28, 2020	Revision 0.9	Initial Release



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